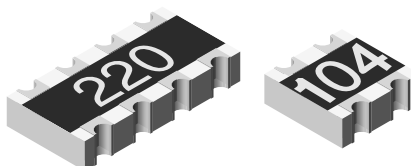


## Thick Film Resistor Array



CRA06P Thick Film resistor array is constructed on a high grade ceramic body with concave terminations. A small package enables the design of high density circuits. The single component reduces board space, component counts and assembly costs.

### FEATURES

- Concave terminal array with square corners
- 4 and 8 terminal package with isolated resistors
- Wide ohmic range: 10R to 1M $\Omega$
- Lead (Pb)-free solder contacts on Ni barrier layer
- Pure tin plating provides compatibility with lead (Pb)-free and lead containing soldering processes
- Compatible with "Restriction of the use of Hazardous Substances" (RoHS) directive 2002/95/EC (issue 2004)



### STANDARD ELECTRICAL SPECIFICATIONS

MODEL	CIRCUIT	POWER RATING $P_{70^{\circ}\text{C}}$ W	LIMITING ELEMENT VOLTAGE MAX. $V_{\text{E}}$	TEMPERATURE COEFFICIENT ppm/K	TOLERANCE %	RESISTANCE RANGE $\Omega$	E-SERIES
CRA06P	03	0.063	50	$\pm 100$ $\pm 200$	$\pm 1$ $\pm 2; \pm 5$	10R - 1M $\Omega$	24 + 96 24
Zero-Ohm-Resistor: $R_{\text{max.}} = 50 \text{ m}\Omega$ , $I_{\text{max.}} = 1 \text{ A}$							

### TECHNICAL SPECIFICATIONS

PARAMETER	UNIT	CRA06P 03 CIRCUIT
Rated Dissipation at 70 °C <sup>(2)</sup>	W per element	0.063
Limiting Element Voltage <sup>(1)</sup>	$V_{\text{E}}$	50
Insulation Voltage (1 min)	$V_{\text{dc/ac peak}}$	100
Category Temperature Range	°C	- 55 to + 155
Insulation Resistance	$\Omega$	$> 10^9$

#### Notes

<sup>(1)</sup> Rated voltage:  $\sqrt{P \times R}$

<sup>(2)</sup> The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155 °C is not exceeded.

### PART NUMBER AND PRODUCT DESCRIPTION

PART NUMBER: CRA06P08347K0JTA <sup>(3)</sup>

PART NUMBER CR06P08347K0JTAA																	
C	R	A	0	6	P	0	8	3	4	7	K	0	J	T	A		
MODEL	TERMINAL STYLE		PIN	CIRCUIT	VALUE		TOLERANCE		PACKAGING <sup>(4)</sup>		SPECIAL						
CRA06	P		04 08	3 = 03	R = Decimal K = Thousand M = Million 0000 = 0 Ω Jumper		F = ± 1 % G = ± 2 % J = ± 5 % Z = 0 Ω Jumper		TA TC		Up to 2 digits						

PRODUCT DESCRIPTION: CRA06P 08 03 473 J RT1 e3

CRA06P	08	03	473	J	RT1	e3
MODEL	TERMINAL COUNT	CIRCUIT TYPE	RESISTANCE VALUE	TOLERANCE	PACKAGING <sup>(4)</sup>	LEAD (Pb)-FREE
CRA06P	04 08	03	473 = 47 k $\Omega$ 4702 = 47 k $\Omega$ 10R0 = 10 $\Omega$ 100 = 10 $\Omega$ 000 = 0 $\Omega$ Jumper First two digits (3 for 1 %) are significant. Last digit is the multiplier.	F = $\pm 1\%$ G = $\pm 2\%$ J = $\pm 5\%$ Z = 0 $\Omega$ Jumper	RT1 RT6	e3 = Pure tin Termination finish

#### Notes

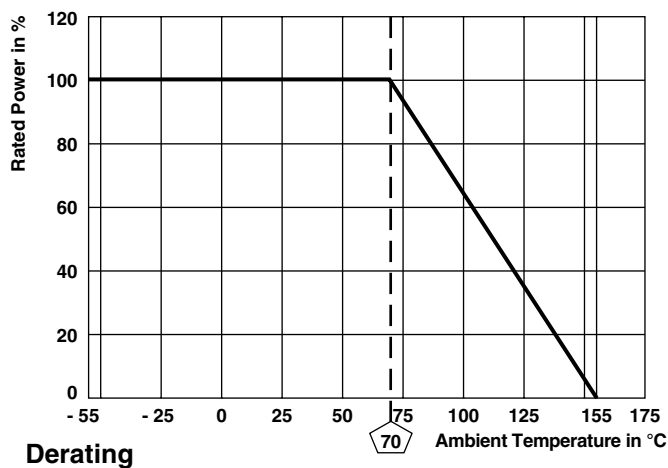
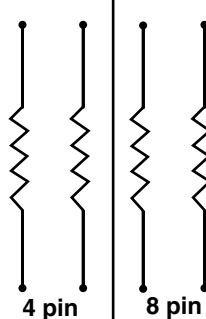
<sup>(3)</sup> Preferred way for ordering products is by use of the PART NUMBER

<sup>(4)</sup> Please refer to the table PACKAGING, see next page

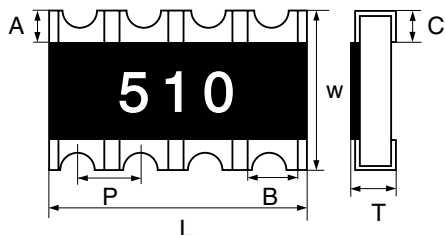
PACKAGING						
MODEL	TAPE WIDTH	DIAMETER	PITCH	PIECES /REEL	PACKAGING CODE	
					PAPER TAPE	
					PART NUMBER	PRODUCT DESCRIPTION
CRA06P	8 mm	180 mm/7"	4 mm	5000	TA	RT1
		330 mm/13"	4 mm	20 000	TC	RT6

## CIRCUIT

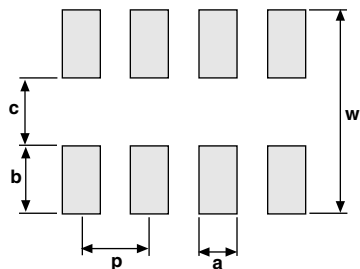
03 CIRCUIT



## DIMENSIONS



PIN NO#	DIMENSIONS [in millimeters]						
	L	A	B	C	P	T	W
4	1.60	0.30	0.40	0.40	0.80	0.60	1.60
8	3.20	0.30	0.40	0.40	0.80	0.60	1.60
Tol.	± 0.20	± 0.20	± 0.15	± 0.20	-	± 0.10	± 0.15



SOLDER PAD DIMENSIONS [in millimeters]					
	c	w	p	a	b
WAVE	0.8	2.6	0.8	0.4	0.9

## TEST PROCEDURES AND REQUIREMENTS

EN 60115-1			
TEST (clause)	CONDITIONS OF TEST	REQUIREMENTS PERMISSIBLE CHANGE ( $\Delta R/R$ ) <sup>(1)</sup>	
		STABILITY CLASS 1 OR BETTER	STABILITY CLASS 2 OR BETTER
	Stability for product types:  <b>CRA06P</b>	10 $\Omega$ to 1 M $\Omega$	10 $\Omega$ to 1 M $\Omega$
Resistance (4.5)	-	$\pm 1 \%$	$\pm 2 \%$ ; $\pm 5 \%$
Temperature coefficient (4.8.4.2)	20/- 55/20 °C and 20/125/20 °C	$\pm 100$ ppm/K	$\pm 200$ ppm/K
Overload (4.13)	$U = 2.5 \times (P_{70} \times R)^{1/2}$ $\leq 2 \times U_{max.}$ ; 0.5 s	$\pm (0.25 \% R + 0.05 \Omega)$	$\pm (0.5 \% R + 0.05 \Omega)$
Solderability (4.17.5) <sup>(2)</sup>	Aging 4 h at 155 °C, dryheat Solder bath method; 235 °C; 2 s Visual examination	Good tinning ( $\geq 95 \%$ covered) no visible damage	
Resistance to soldering heat (4.18.2)	Solder bath method; (260 $\pm$ 5) °C; (10 $\pm$ 1) s	$\pm (0.25 \% R + 0.05 \Omega)$	$\pm (0.5 \% R + 0.05 \Omega)$
Rapid change of temperature (4.19)	30 min at LCT = - 55 °C; 30 min at UCT = 125 °C; 5 cycles	$\pm (0.25 \% R + 0.05 \Omega)$	$\pm (0.5 \% R + 0.05 \Omega)$
Damp heat, steady state (4.24)	(40 $\pm$ 2) °C; 56 days; (93 $\pm$ 3) % RH	$\pm (1 \% R + 0.05 \Omega)$	$\pm (2 \% R + 0.1 \Omega)$
Climatic sequence (4.23)	16 h at UCT = 125 °C; 1 cycle at 55 °C; 2 h at LCT = - 55 °C; 1 h/1 kPa at 15 °C to 35 °C; 5 cycles at 55 °C $U = (P_{70} \times R)^{1/2}$ $U = U_{max.}$ ; whichever is less severe	$\pm (1 \% R + 0.05 \Omega)$	$\pm (2 \% R + 0.1 \Omega)$
Endurance at 70 °C (4.25.1)	$U = (P_{70} \times R)^{1/2}$ $U = U_{max.}$ ; whichever is less severe 1.5 h ON; 0.5 h OFF; 70 °C; 1000 h	$\pm (1 \% R + 0.05 \Omega)$	$\pm (2 \% R + 0.1 \Omega)$
Extended endurance (4.25.1.8)	Duration extended to 8000 h	$\pm (2 \% R + 0.1 \Omega)$	$\pm (4 \% R + 0.1 \Omega)$
Endurance at upper category temperature (4.25.3)	UCT = 125 °C; 1000 h	$\pm (1 \% R + 0.05 \Omega)$	$\pm (2 \% R + 0.1 \Omega)$

### Notes

<sup>(1)</sup> Figures are given for a single element

<sup>(2)</sup> Solderability is specified for 2 years after production or requalification. Permitted storage time is 20 years

## APPLICABLE SPECIFICATIONS

• EN 60115-1	Generic Specification
• EN 140400	Sectional Specification
• EN 140401-802	Detail Specification
• IEC 60068-2-X	Variety of environmental test procedures
• EIA 481	Packaging of SMD components



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